



Connectors > Contacts > Connector Contacts



Contact Type: **Pin**

Contact Mating Area Plating Material: **Silver (Ag)**

Operating Voltage: **250 VDC**

Contact Retention Within Housing: **Without**

Features

Product Type Features

Sealable	No
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Electrical Characteristics

Operating Voltage	250 VDC
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Contact Features

Contact Underplating Material	Nickel
Contact Orientation	Straight
Mating Pin Diameter	6 mm[.236 in]
Contact Underplating Material Thickness	1.27 µm[50 µin]
Contact Mating Area Plating Material Thickness	5.08 – 10.16 µm[200 – 400 µin]
Contact Mating Area Plating Material Finish	Semi-Bright
Contact Type	Pin
Contact Mating Area Plating Material	Silver (Ag)
Contact Retention Within Housing	Without
Contact Base Material	Brass
Contact Current Rating (Max)	100 A

Termination Features

Product Terminates To	Busbar
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Mechanical Attachment

Wire Insulation Support	Without
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Usage Conditions



Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]
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Operation/Application

Circuit Application	Power
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Packaging Features

Packaging Quantity	24
Packaging Method	Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) SVHC > Threshold: Pb (3.7% in 74019790) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

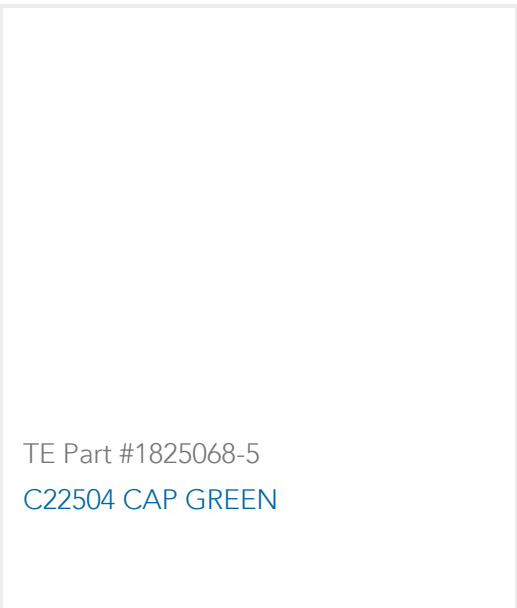
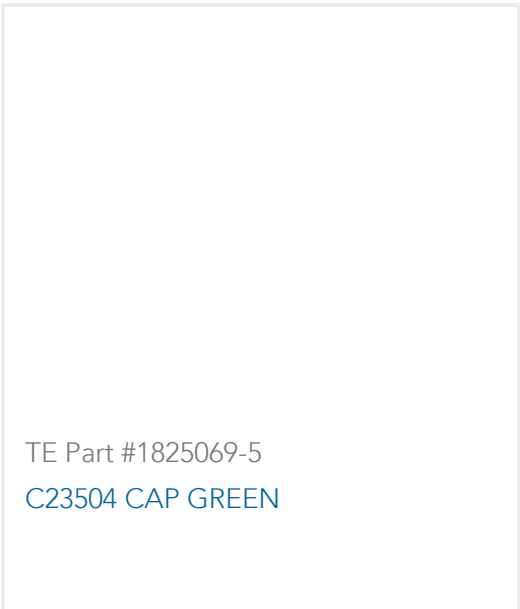
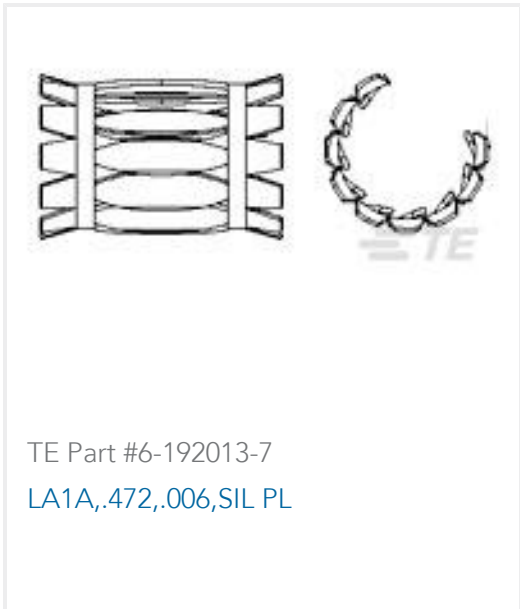
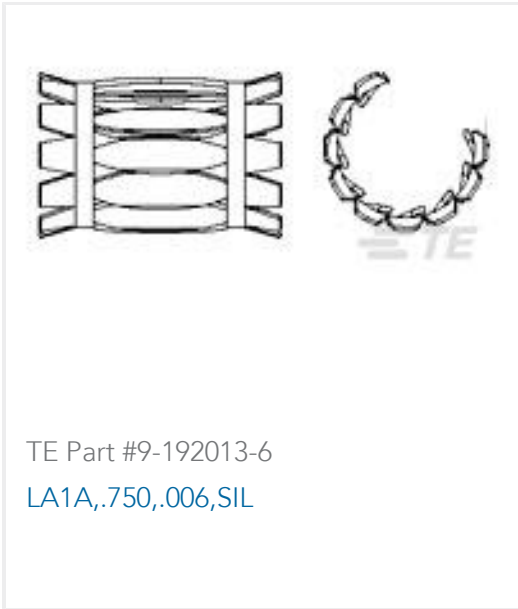
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Customers Also Bought



Documents

Product Drawings

6MM TMP 1/4-28

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_192244-1_E.2d_dxf.zip



English

Customer View Model

[ENG_CVM_CVM_192244-1_E.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_192244-1_E.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[POWER_CONNECTORS_CATALOG_SEC02_CABLE_MOUNTED](#)

English

Product Specifications

[Application Specification](#)

English